© Copyright 2005.	© Copyright 2005 IPC Bannockburn Illinois All rights reserved under both				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
				Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					ials and N	als and Mfg Information			
Supplier Information														
Company name*	Company unique ID				Unique ID Authority				Respon	Response Date*				
onsemi									2023-0	2023-06-08				
Contact Name Title			Title - Contact			Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative*	Title - Representative			Phone - Representative*			Email ·	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Version		Manufacturing Site		Weight*	UOM	Unit Type	
	CAT24C	CAT24C512C8UTR 512KB I2C SER E overall thickness is			(max	2023-06-08	CNQ			1.8162	mg	Each		
Manufacturing Proccess Inform	ation													
Terminal Plating / Grid Array Material Ter		erminal Base Alloy J-STD-020 MSL		Rating	Peak Process Body Temperature Max Time at		re Max Time at Peal	ak Temperature Number of Reflow Cycles						
SnAgCu CU A		CU Alloy	1			260 C 30		seconds 3						
Comments														
level 1 - maximum time at peak tempera	ure during so	Idering is 10-3	0 seconds											
For more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Backside Protection Film	0.0813	mg		Epoxy resin	proprietary data		0.017	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0015	mg	
			Supplier	Acrylic resins	Proprietary Data		0.017	mg	
			Supplier	Silica (SiO2)	14464-46-1		0.0458	mg	
Die	1.4837	mg	Supplier	Silicon (Si)	7440-21-3		1.4837	mg	
Plating	0.1065	mg	Supplier	Silver (Ag)	7440-22-4		0.0027	mg	
			Supplier	Tin (Sn)	7440-31-5		0.1038	mg	
Protection coat	0.065	mg		Polyimide	proprietary data		0.065	mg	
RDL	0.0473	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg	
			Supplier	Copper (Cu)	7440-50-8		0.047	mg	
UBM Sputter	0.0324	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0322	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3